Docket No.: M4065.0468/P468-B

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Phillip E. Byrd, et al.

Application No.: NOT YET ASSIGNED

Art Unit: N/A

Filed: Concurrently Herewith

Examiner: Not Yet Assigned

For: METHOD FOR TEMPORARILY

ISOLATING A DIE FROM A COMMON CONDUCTOR TO FACILITATE WAFER LEVEL TESTING (AS AMENDED)

FIRST PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to examination on the merits, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 6 of this paper.

Remarks/Arguments begin on page 11 of this paper.